

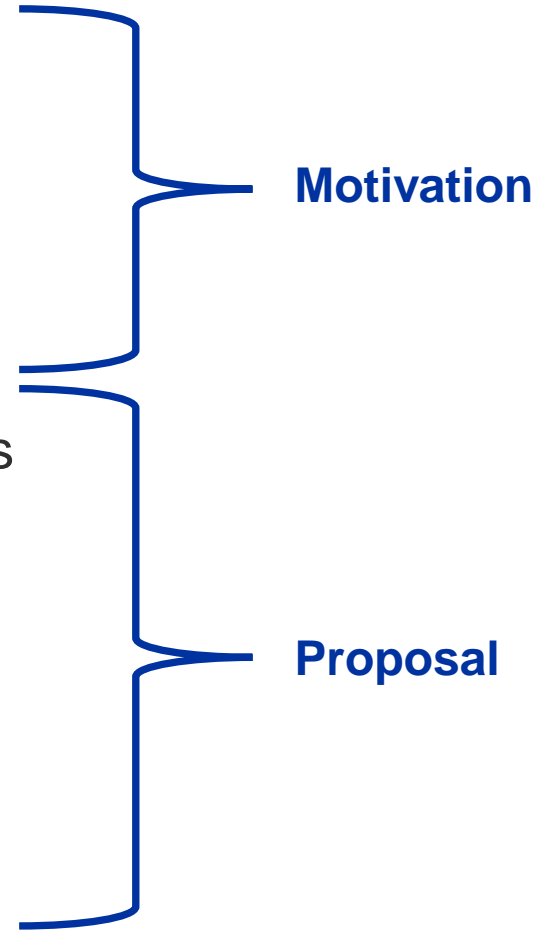
# **Cryogenic Tests of Electronic Components and Sensors for Superconducting Magnet Instrumentation**

Vincenzo Di Capua, Marco Buzio, Lucio Fiscarelli, Unai Martinez

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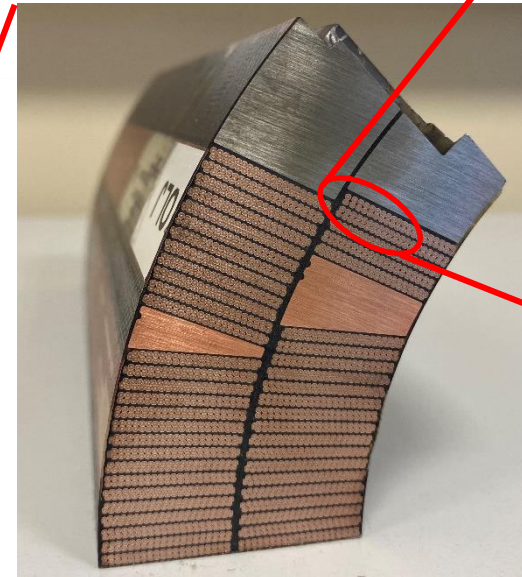
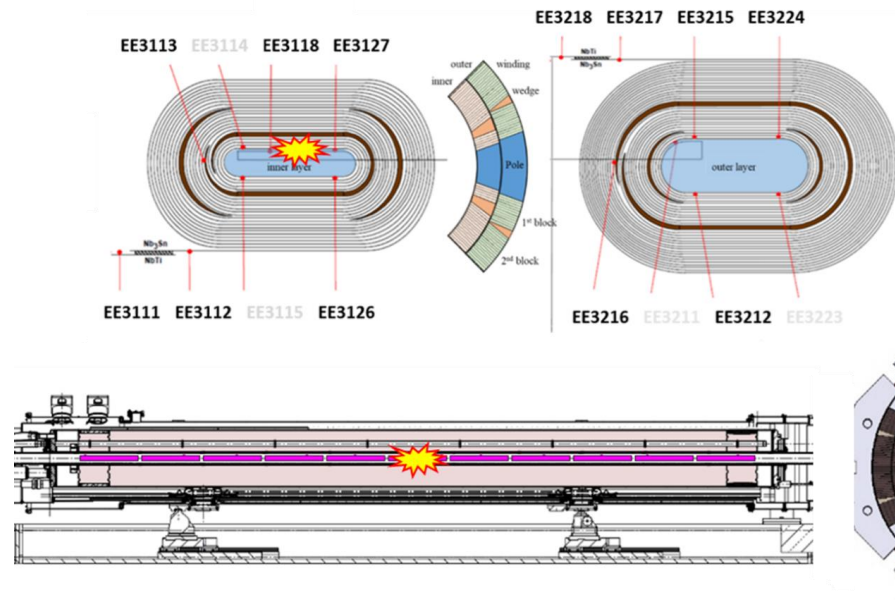
# Table of contents

- Quench localization
- Quench localization methods
- Electronics for quench localization
- Needs
- Current limitations
- Embedded detection and controlling electronics
- Cryogenic electronics
- Selected components
- Evaluation board
- Test plan and setup
- Results
- Future perspectives
- Conclusions



# Quench localization

- Identifying the starting location of a quench during superconducting magnets training is critical:
  - To identify **defects**.
  - To drive the **design** and the **manufacturing**.
  - For **protection** systems.



# Quench localization methods

## ▪ Electrical

- **Passive:** voltage taps to monitor the resistance.
- **Active:** AC signals to measure impedance, reflectometry, or stray capacitances.

## ▪ Magnetic

- Array of **induction coils**.
- Array of **Hall sensors**.

## ▪ Mechanical

- **Acoustic emission** sensors.

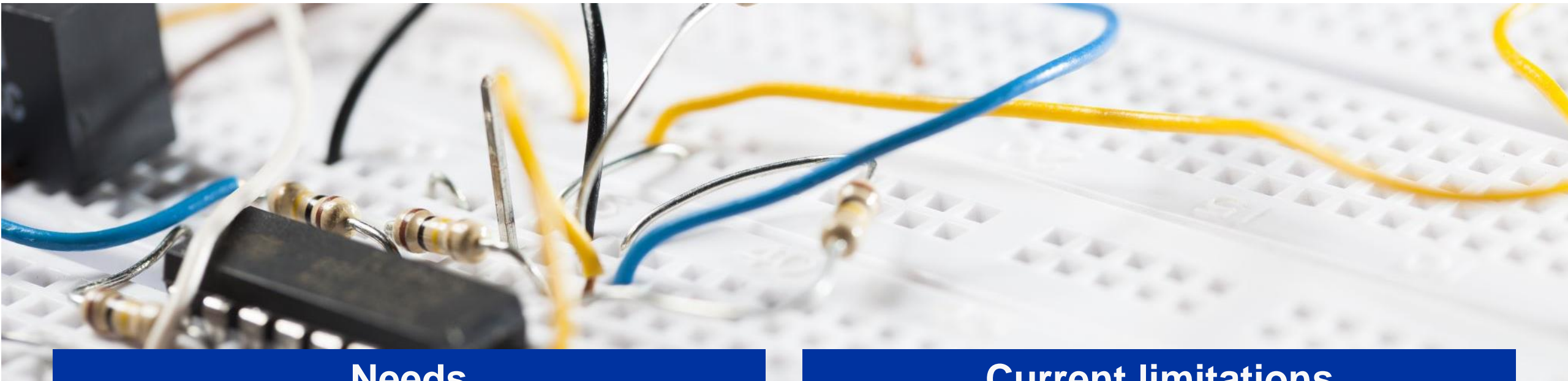
## ▪ Thermal

- **Fiber-optic** sensors.

➤ **Voltage taps and induction coils are widely used for LTS magnets.**

➤ **All others are considered promising for HTS magnets.**

# Electronics for quench localization



## Needs

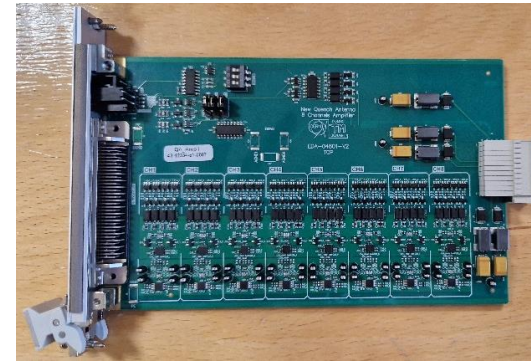
- Acquire a large number ( $>40$ ) of signals.
- Signal conditioning (mV range).
- High sample rate ( $>50$  kHz).

## Current limitations

- The number of signals.
- Signal integrity.
- Environmental noise.

# Needs

- **Acquire a large number (>40) of signals.**
  - **Internal:** V taps, induction coils, Hall probes.
  - **External:** Quench antenna, Hall probes.
- **Signal conditioning (mV range).**
  - Multi-stage **amplifiers** to increase the **SNR**.
  - Antialiasing **filtering**.
- **High sample rate (>50 kHz).**
  - To capture the full **dynamic** of the acquired signals.



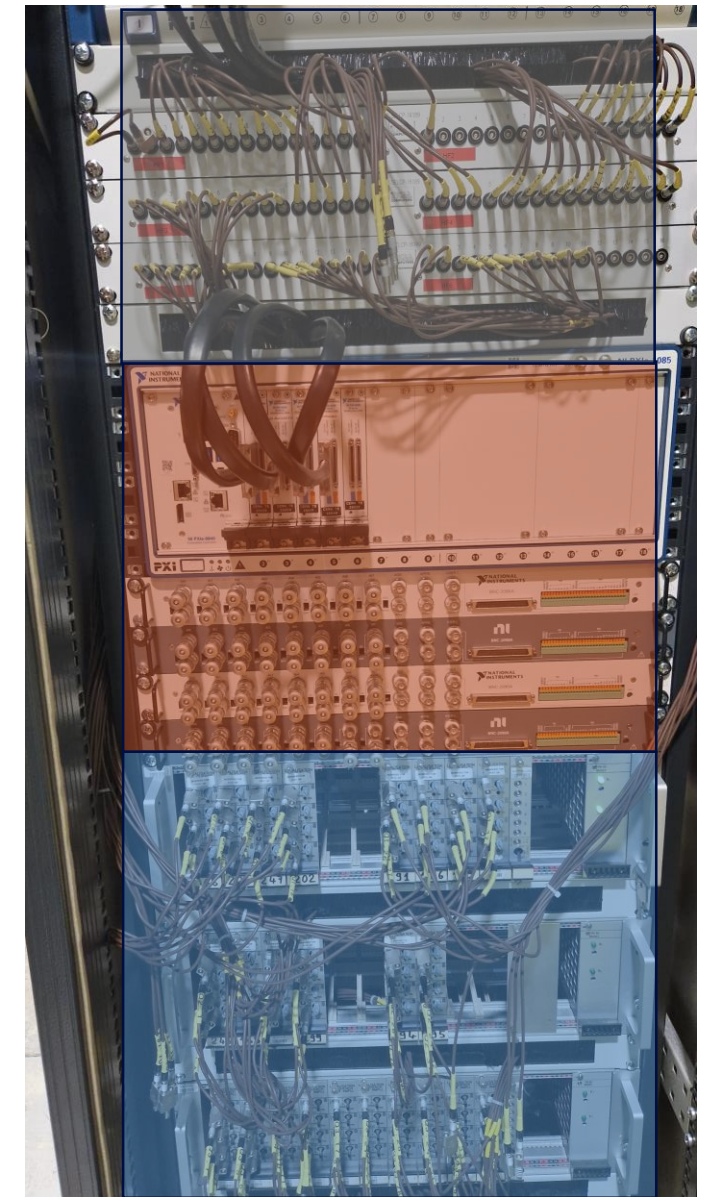
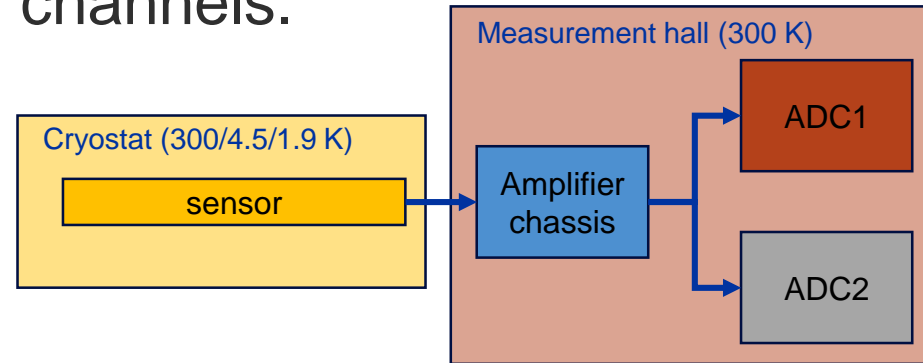
Custom design of amplifier cards and crates for Quench Antenna.



Commercial acquisition system with real-time processing.

# Current limitations

- **The number of signals.**
  - **Internal:** Number of signals that are possible to extract from the cryostat.
  - **External:** Acquisition channels.
- **Signal integrity.**
  - Due to several **interconnections.**
- **Environmental noise.**
  - **Captured** by sensors and cables.



Quench Antenna conditioning and acquisition rack.

# Embedded detection and conditioning electronics

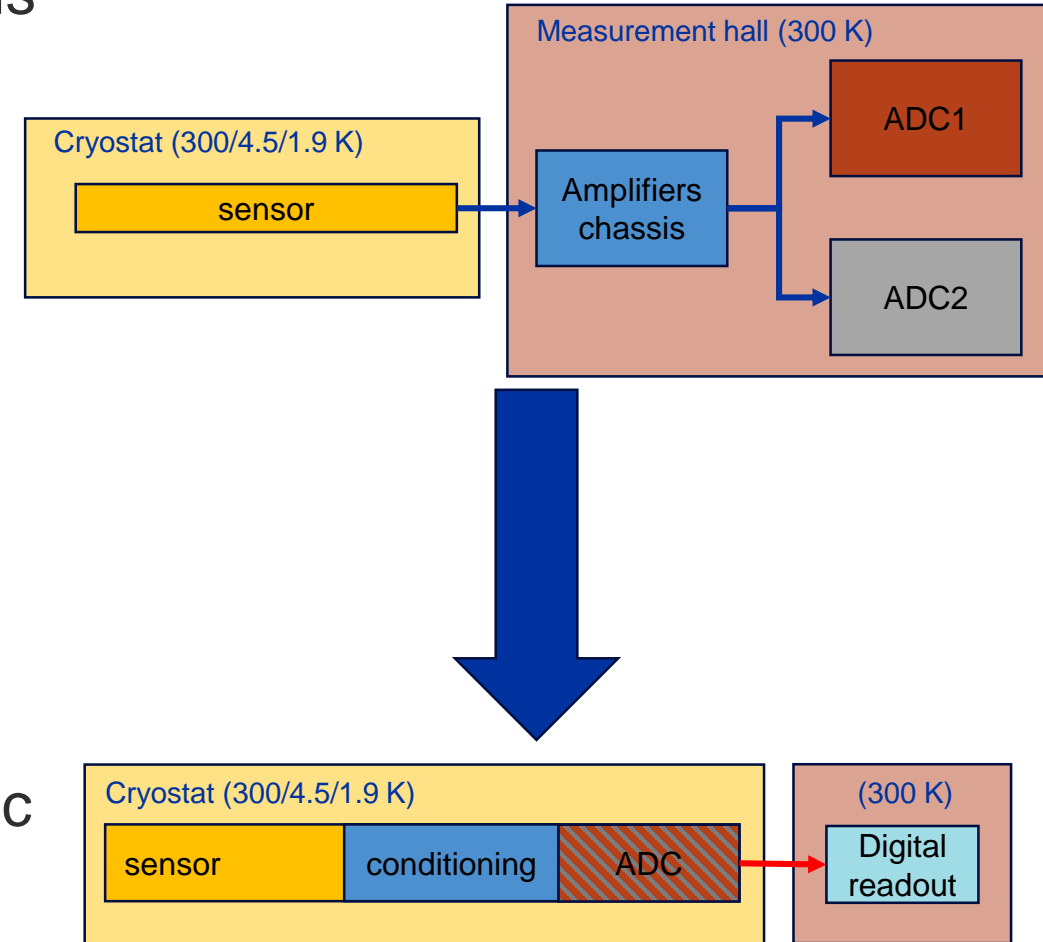
- One Approach to mitigate most of these limitations would be to **embed the whole chain** into the sensors and/or into the cryostat:

- **Signal conditioning:**

- Shorter distances.
- Fewer interconnections.

- **Digitalization:**

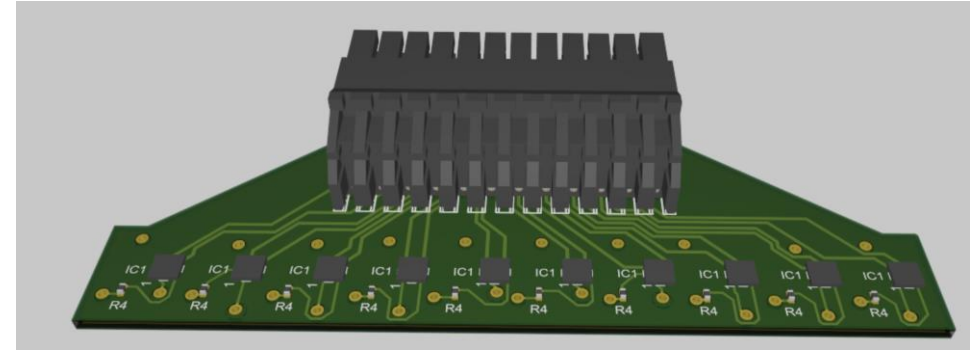
- **Reduced impact** of external electromagnetic disturbances.
- We need to **extract** only a few **digital signals**.



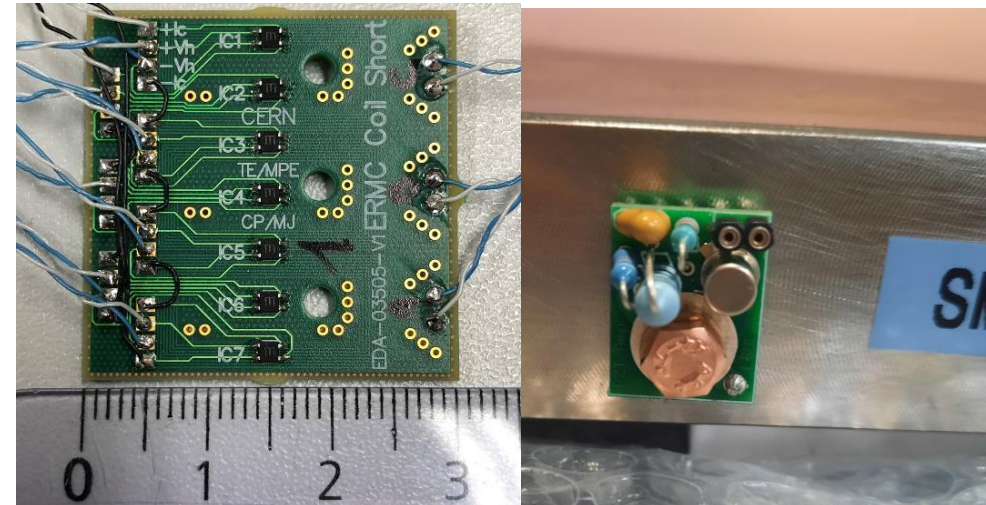


# Cryogenic electronics

- A crucial aspect to be investigated is **to embed sensors and electronics** in the superconducting **magnets' cryostats**.
- A **vast literature** on using commercial microphones, Hall probes, and conditioning **electronics at cryogenic temperatures** (4.5 and 1.9 Keven if only in dry conditions)[[1](#),[2](#),[3](#),[4](#)]
- Each component family and each manufacturer **must be evaluated individually**.



Hall probe array for cryogenic environments.



Hall probe sensors already in use on racetrack magnets (left) (credits: Carlo Petrone). Piezoelectric cryogenic sensor with embedded amplifier (right).

[1] [Marchevsky, M. \(2022\). Understanding training in superconducting accelerator magnets using acoustic emission diagnostics. arXiv preprint arXiv:2203.08871.](#)

[2] [D. Conway Lamb, et All; An FPGA-based instrumentation platform for use at deep cryogenic temperatures. Rev. Sci. Instrum. 1 January 2016; 87 \(1\): 014701.](#)

[3] [Song, M., et All,\(2018, March\). Evaluation of commercial-off-the-shelf \(COTS\) electronics for extreme cold environments. In 2018 IEEE Aerospace Conference \(pp. 1-12\). IEEE.](#)

[4] [Valiente-Blanco, et All \(2013\). Characterization of commercial-off-the-shelf electronic components at cryogenic temperatures. Instruments and Experimental Techniques, 56, 665-671.](#)

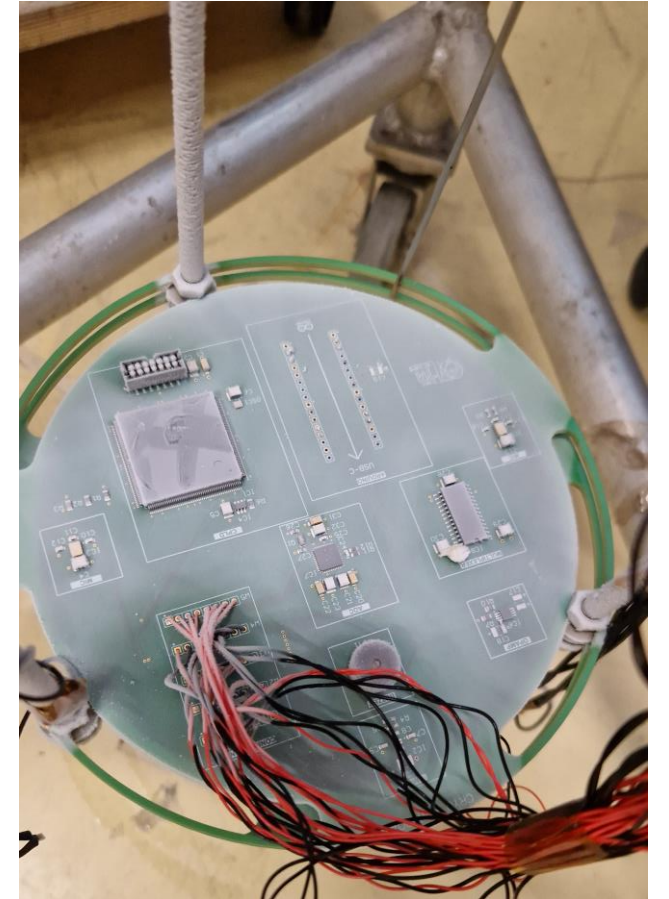
# Selected components

- The components were selected with the final **goal** of building a **complete acquisition chain**.
  - Components have been chosen by taking **inspiration from** the existing **literature**.
  - The test of digital components (**FPGA, MCUs**) has been postponed to the **next test campaign**.

Device	Description
OPA192IDGKT	Operational amplifier
IM73A135V01	MEMS microphone with analog differential output
ADG506AKR	CMOS 16-Channel Analog Multiplexers
KXG1205C	Piezoelectric transducer
SMD Thick Film Resistors	25 k $\Omega$ , 10 k $\Omega$ , 5.1 k $\Omega$ , 4.7 k $\Omega$ , 1.1 k $\Omega$ , 50 $\Omega$
SMD PPS Film Capacitors	100 nF, 2.2 nF, 220 pF, 100 pF, 4.7 pF
SMD Tantalum Capacitors	10 $\mu$ F

# Evaluation board

- **Custom PCB** has been designed to host all the devices under test and provide a suitable **interface for the** signal cable and the 40 available feed-throughs.
- **Test points** have been added to simplify the **debugging** in case of faults.
- Form factor **tailored** to the test head.
- Standard industrial processes, **FR4** dielectric, and **ENIG** surface finish.



PCB for 1<sup>st</sup> campaign of tests of sensor and electronic components at cryogenic temperature.

# Test plan and setup

- All the selected **components** have been **tested at** :
  - **300 K** (room temperature)
  - **77 K** (liquid nitrogen)
  - **4.5 K** (liquid helium)
  - **1.9 K** (superfluid liquid helium)
- **Each test** has been **repeated twice**:
  - **Immediately** after power on.
  - **Check for performance stability.**
- **After each test**, the PCB has always been brought **back to room temperature.**



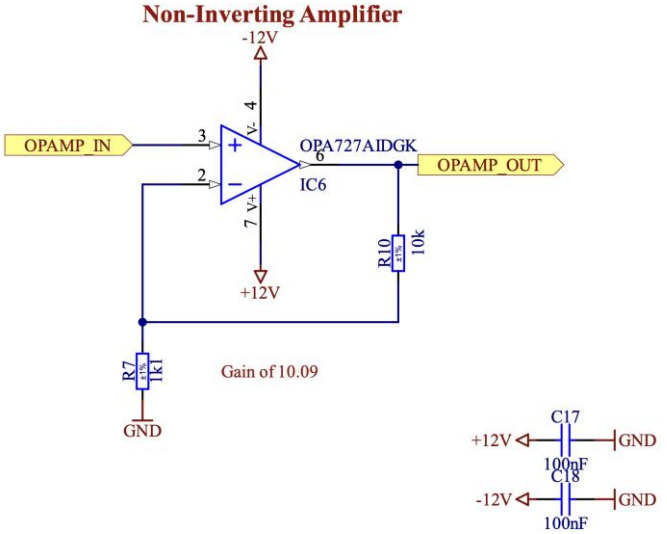
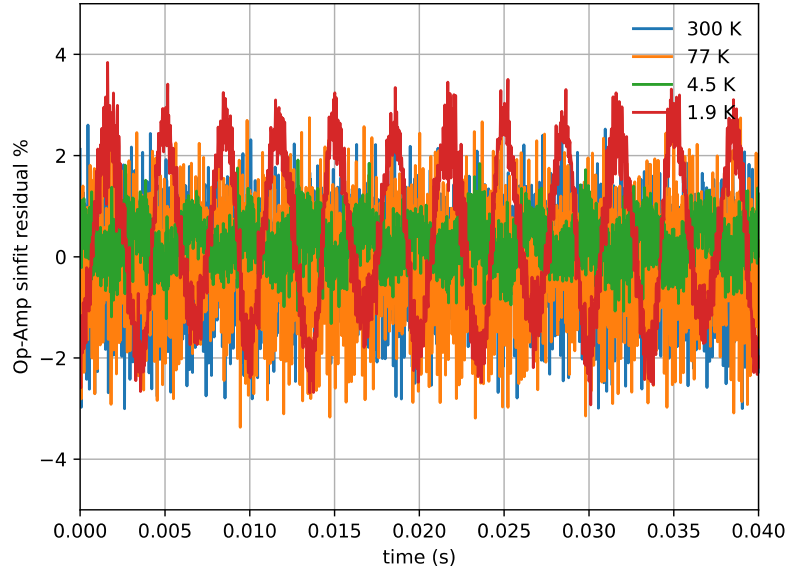
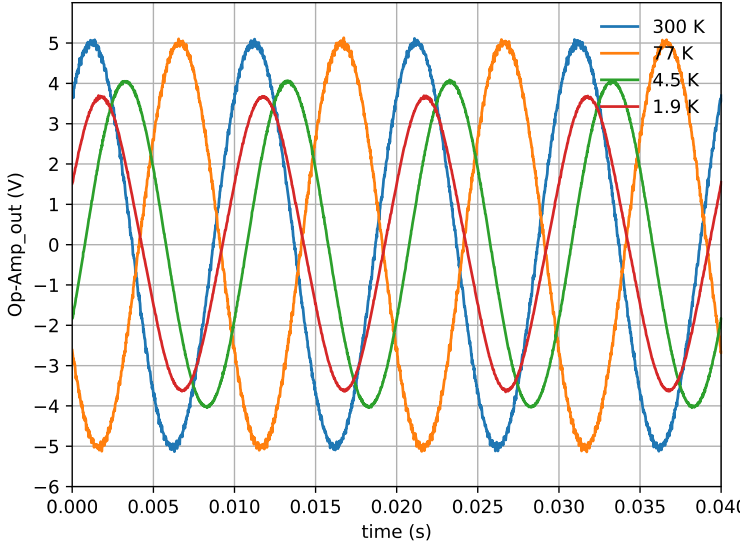
Assembled test head (left), liquid nitrogen tests (right).



setup for the test in liquid Helium at 1.9 K.

# Operational Amplifier

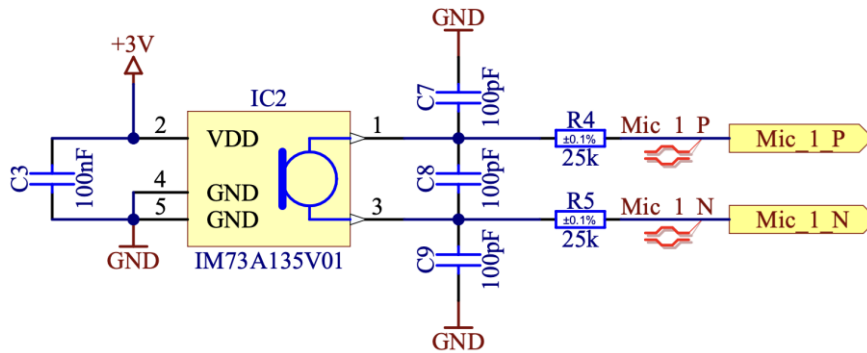
- configured in **non-inverting** mode.
- DC gain of **10**.
- Test (**SNR evaluation**):
  - **1.1 V AC** input at **100 Hz**.
  - output acquired at **50 kHz**.
  - Four parameters **Sinfit**.



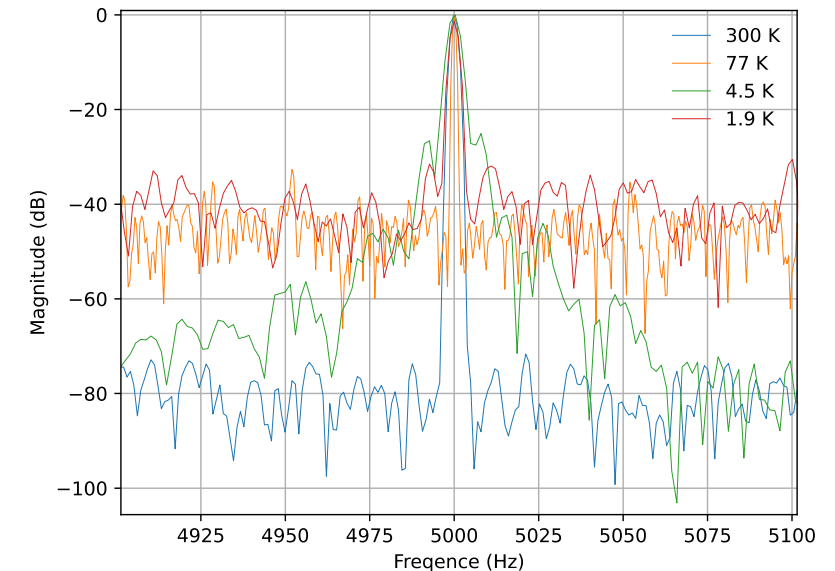
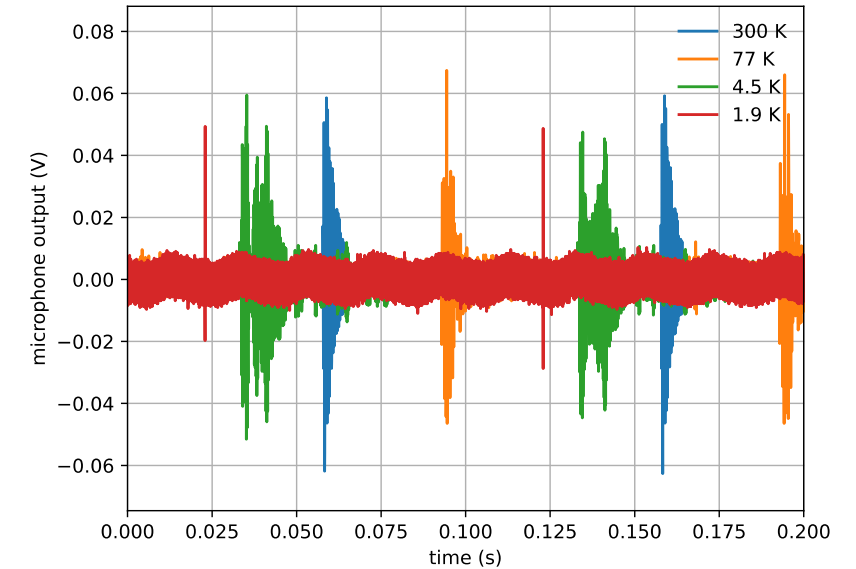
	<b>300 K</b>	<b>77 K</b>	<b>4.5 K</b>	<b>1.9 K</b>
<b>SNR (dB)</b>	<b>74.58</b>	<b>73.66</b>	<b>85.7</b>	<b>65.74</b>

# MEMS microphones

- Acoustic vibrations are provided by a piezoelectric transducer.
- Test the full bandwidth of the sensor.

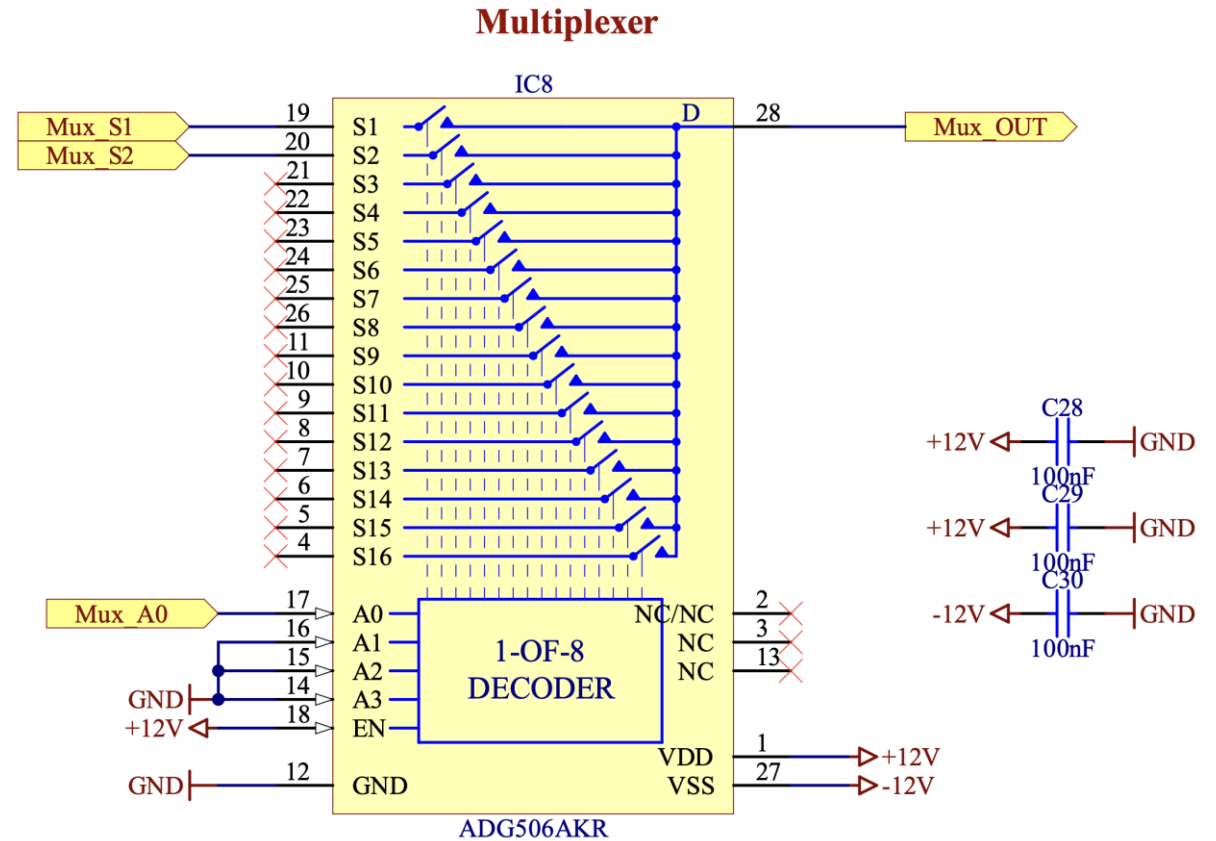


unit mV/V	300 K	77 K	4.5 K	1.9 K
<b>Pulse train</b>	2.1	6.7	5.6	4.9
<b>1 kHz</b>	3.3	0.6	0.7	0.5
<b>5 kHz</b>	1.5	0.5	0.4	0.5
<b>10 kHz</b>	1.9	0.5	0.6	0.6
<b>15 kHz</b>	2.4	0.5	1.5	0.5
<b>20 kHz</b>	1.5	0.5	0.5	0.5



# Multiplexer

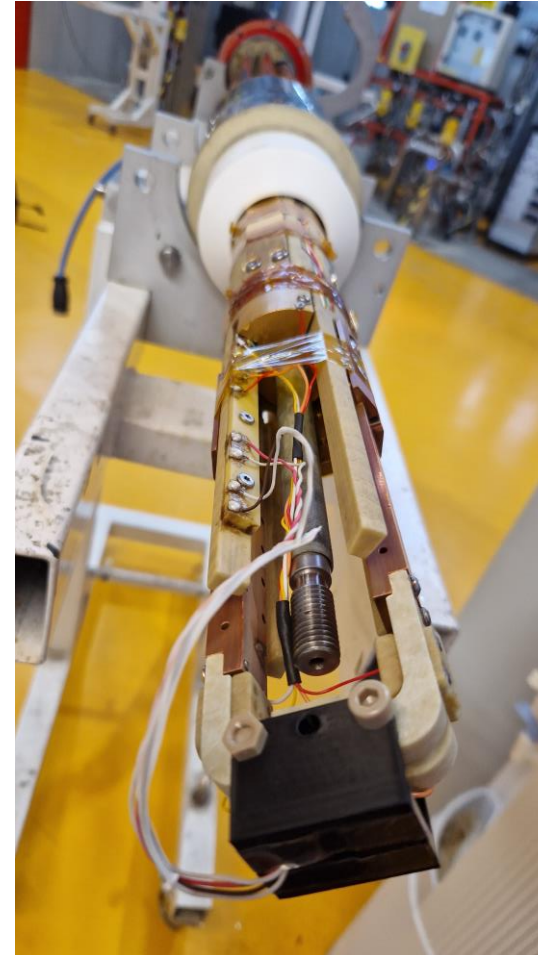
- **In-out resistance** was evaluated for two of the inputs of the multiplexer.
- **Liquid nitrogen** performance comparable with room temperature.
- **Increase in liquid helium** by a factor of almost 2, with a negligible difference between 4.5 K and 1.9 K.
- Component suitable for multiplexing signals at cryogenic temperatures.



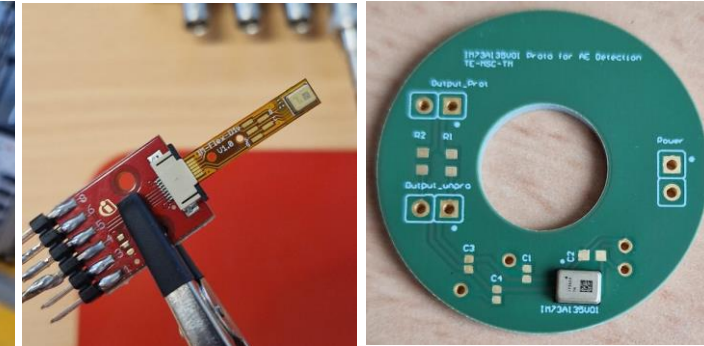
	300 K	77 K	4.5 K	1.9 K
<b>in1-out (<math>\Omega</math>)</b>	166 $\pm$ 1	109 $\pm$ 1	315 $\pm$ 1	328 $\pm$ 1
<b>in2-out (<math>\Omega</math>)</b>	167 $\pm$ 1	57 $\pm$ 1	282 $\pm$ 1	305 $\pm$ 1

# Future perspectives

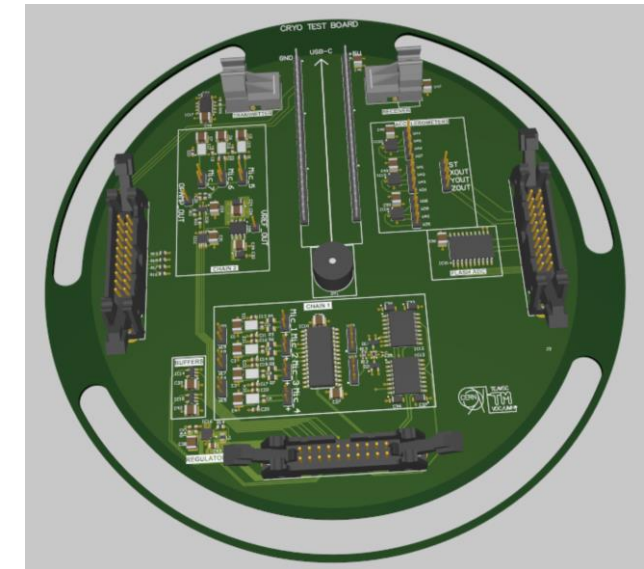
- A **second test campaign** is foreseen.
  - ADC, microcontrollers, and FPGA.
- A small PCB for **integration** of MEMS sensors **on magnet structure** has been developed and characterized.
- **Acoustic emission** during critical current tests of **REBCO tapes** is currently under study.
  - Case study with only one **MEMS sensor** up to 15 T.



Test insert for critical current test on REBCO tapes.



Commercial MEMS microphones (left) and PCB board for integration in the magnet structure (right).



PCB for 2<sup>nd</sup> campaign of tests of sensor and electronic components at cryogenic temperature.



# Conclusions

- **Quench** detection and **localization** are **crucial** for optimizing the design and manufacturing of superconducting magnets.
- Typically, **a large number of small signals** (greater than 40, each a few millivolts) need to be acquired and sometimes extracted from the cryostat.
- Using **cryogenic electronics** for signal conditioning and acquisition can **improve** the signal-to-noise ratio (**SNR**).
- **Individual tests** are necessary to verify the functionality and characterize electronic components beyond the manufacturer's specifications.
- We **successfully tested the signal conditioning chain's essential components** and established a stable setup and procedure.
- **Future tests** are planned to develop a **complete cryogenic acquisition chain**.
- The **tested MEMS** sensors have already been **deployed with success for cryogenic applications**.

**Thanks for the attention!**



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